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Fatigue Analysis of Additive Manufacturing Materials with Microstructural Properties

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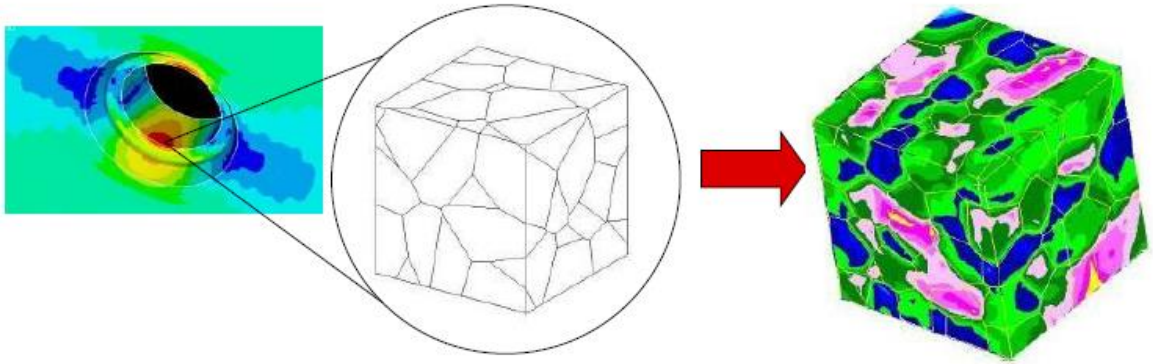


Outline

- Methodology of Fatigue Life Analysis with Microstructural Properties
- High Cycle Fatigue Tests
 - L-PBF AlSi10Mg
 - L-PBF Ti 6Al-4V
- Microstructural Material Property Development of L-PBF AlSi10Mg and Ti 64 Specimens
- Comparison of Test Data and Analysis Results
- Conclusion
- Future Works



Methodology of Fatigue Life Analysis with Microstructural Properties



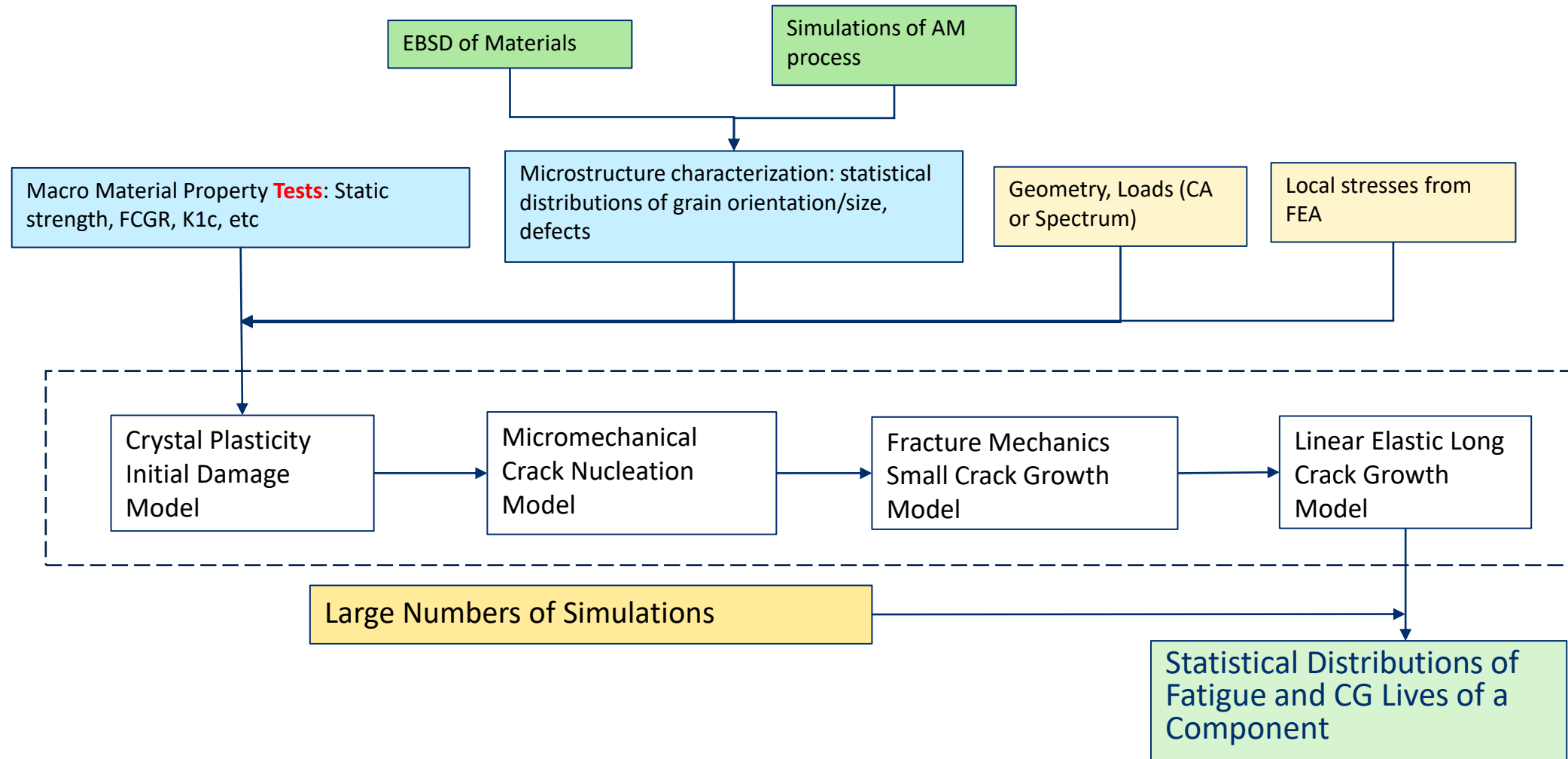
Fatigue and Crack Growth Analysis of AM Materials: ICME Application

- Since microstructural properties are different per base power, machine specification, and material process, microstructural analysis is required for AM material fatigue analysis.
- Cost and schedule constraints to test each case by materials and processes.
- Need to quantify effects of AM process variations on mechanical performance of AM-built parts
- Simulate different microstructures and develop statistical distributions of microstructural properties.
- To capture variability of AM material properties, probabilistic approach is needed with statistical distributions.

AM is an Ideal Case of ICME Application



AM Fatigue Life Process

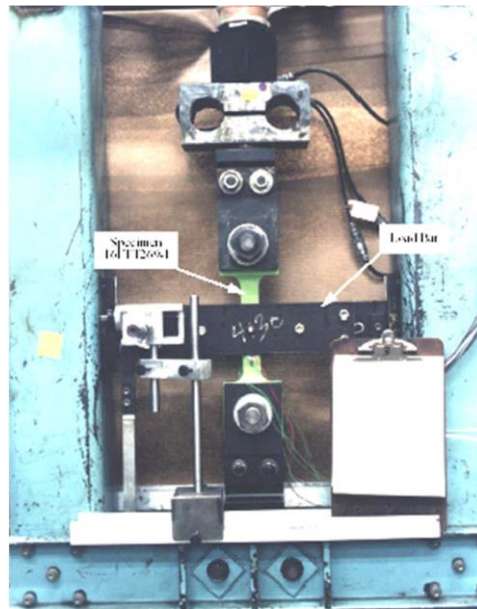


Fatigue Analysis of AM, VPS-MICRO

- VEXTEC developed a fatigue analysis tool that predicts fatigue life with statistical distributions of microstructure, VPS-MICRO
- VPS-MICRO utilizes Monte Carlo analysis method combining the models of dislocation theory with random variable statistics
- VPS-MICRO has three stages of fatigue life: crack initiation, small crack growth and long crack growth
 - Crack initiation: smooth fracture surfaces at angle inclined to the loading direction -> shear stress fracture
 - The equilibrium condition of the grain on the first loading: $\tau_1^D + (\tau_1 - k) = 0$
 - Small Crack Growth: a function of the crack tip opening displacement (CTOD). Used the theory of continuously distributed dislocation to model the CTOD $\frac{da}{dN} = C'(\Delta COD)^{n'}$
 - Long Crack Growth: Linear Elastic Fracture Mechanics (LEFM) and not affected by microstructure

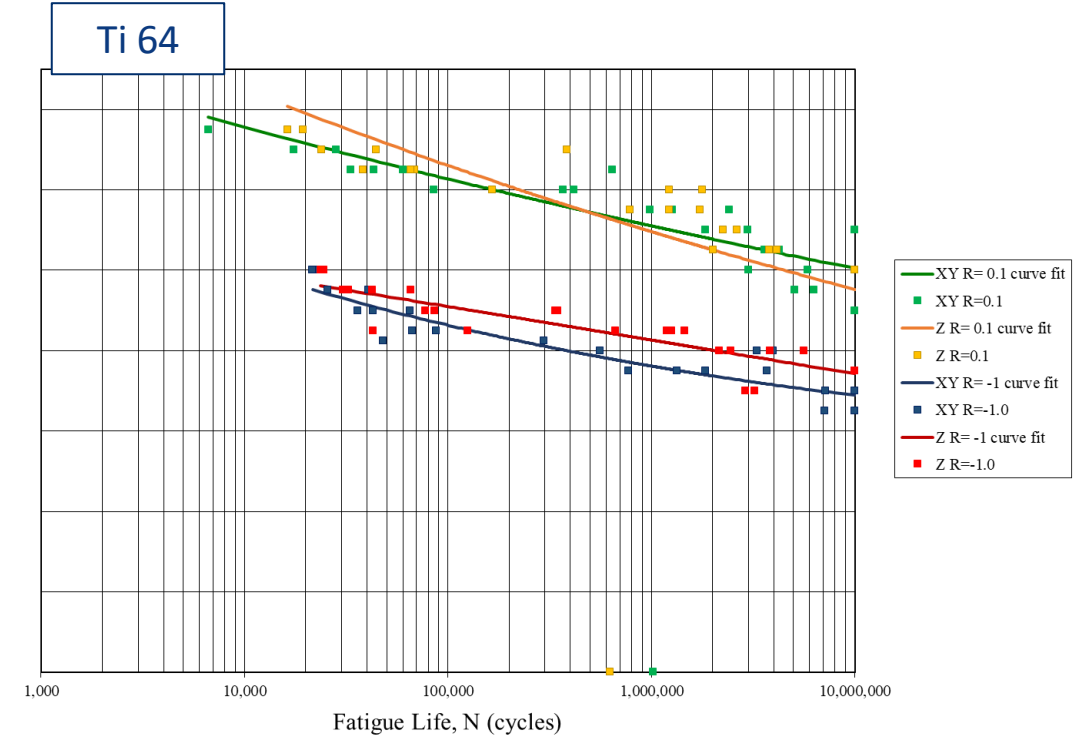
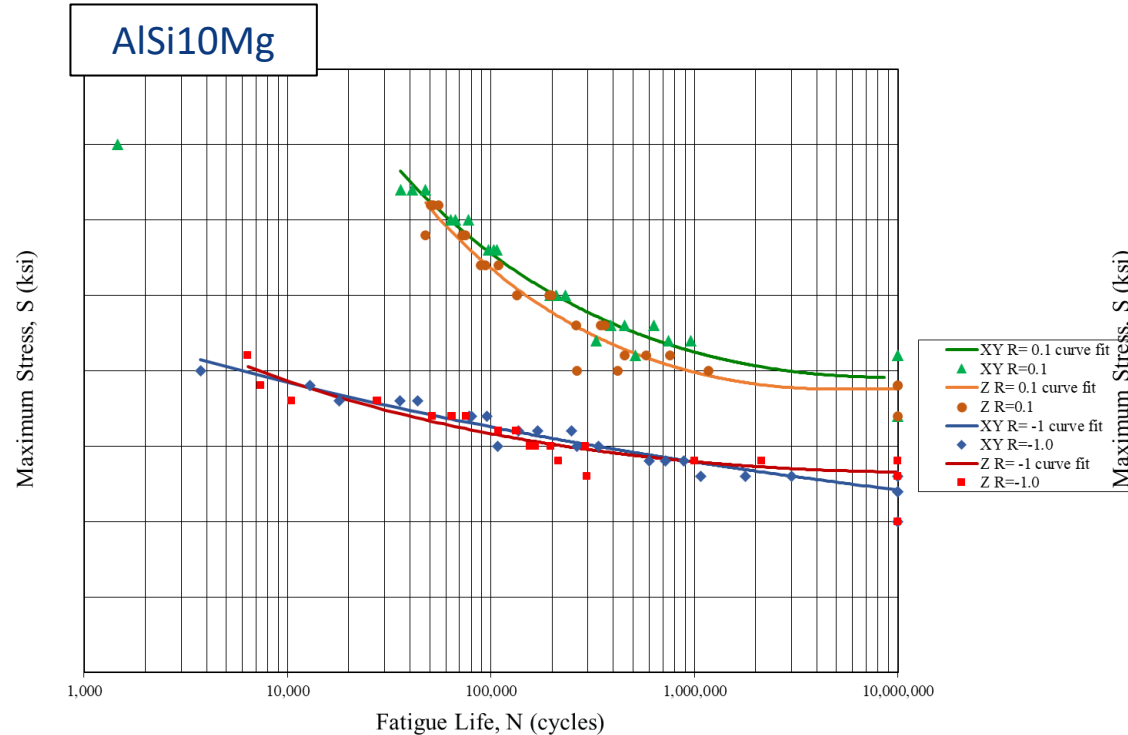
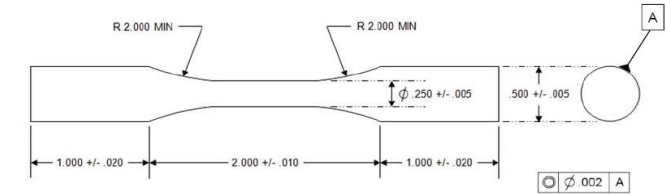


High Cycle Fatigue Test of L-PBF AlSi10Mg and Ti 6Al-4V

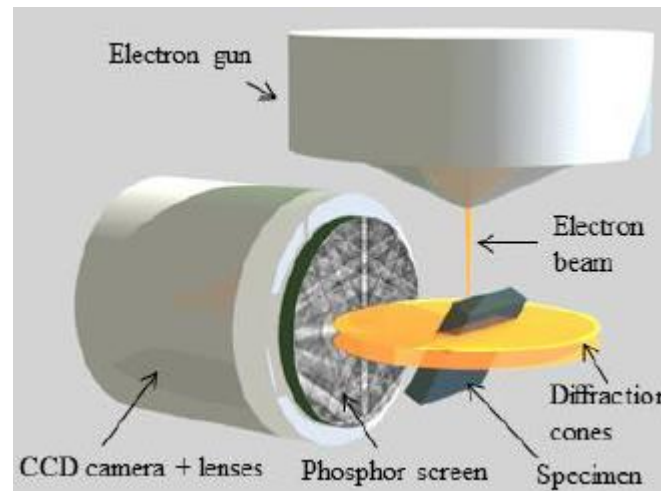


High Cycle Fatigue Tests

- L-PBF AlSi10Mg and Ti 6Al-4V specimens were built per LM AM material and process specifications.
 - Ambient temperature
 - xy and z build directions
 - Ti 64 specimens were hot isostatic pressed (HIP) and annealed
- HCF tests were run at two stress ratios, R=0.1 and -1

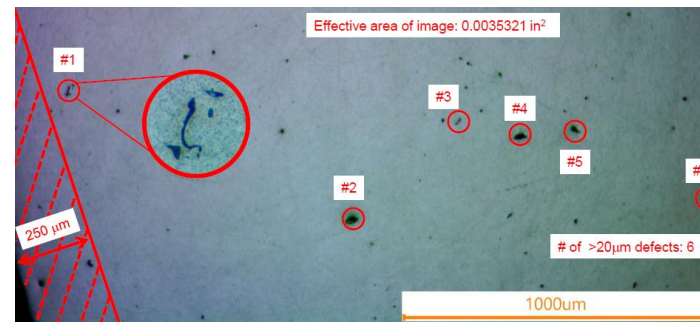


Microstructural Material Property Development



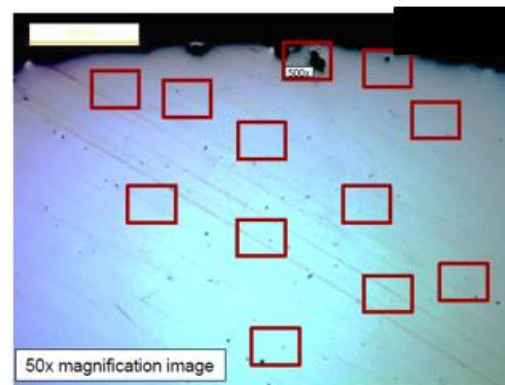
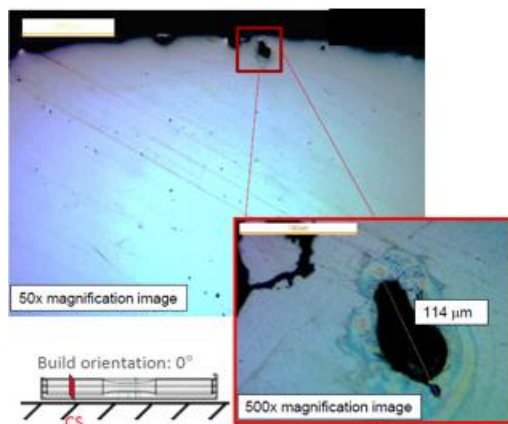
Defects of PBF AlSi10Mg Specimens

- In the magnified images, some lack-of-fusion features were identified.
- The largest dimension of each defect over 20μm in size was measured, and defect size and defect population density distributions are calculated.



Z-Build

$$\text{Mean: } \bar{x}_{\text{defect size}} = \frac{\sum \text{defect sizes in a given sample}}{N_{\text{defects} > 20\mu\text{m}}}$$



XY-Build

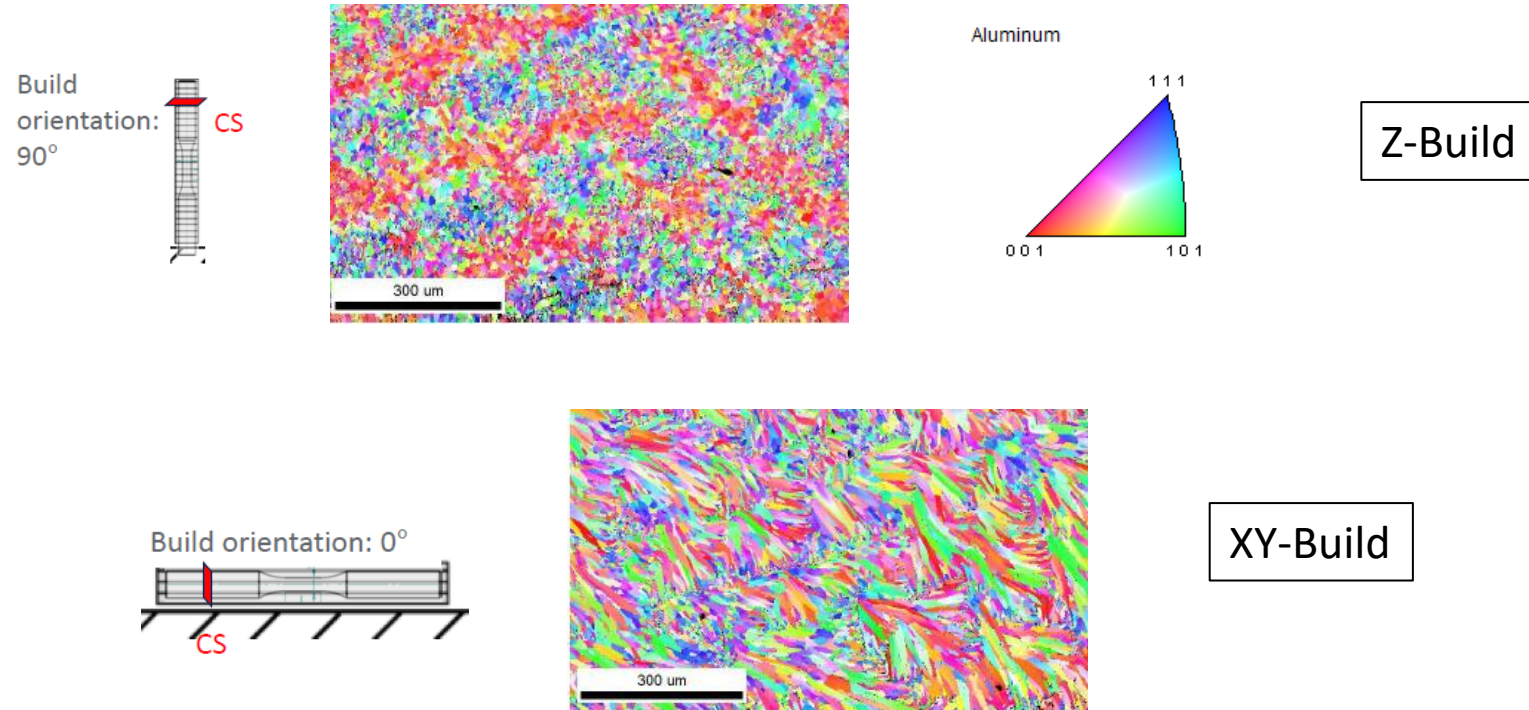
$$\text{Standard Deviation: } s = \sqrt{\frac{1}{N_{\text{defects}} - 1} \sum_i^N (x_i - \bar{x})^2}$$

$$\text{Coefficient of Variation: } COV = \frac{s}{\bar{x}}$$



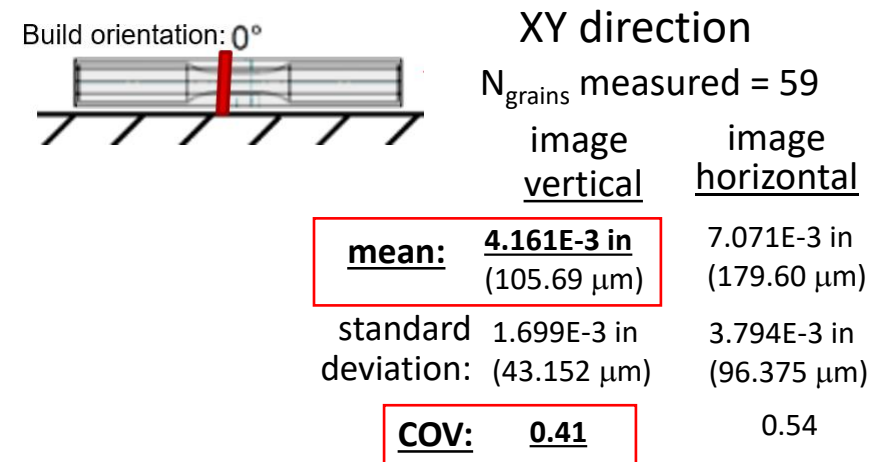
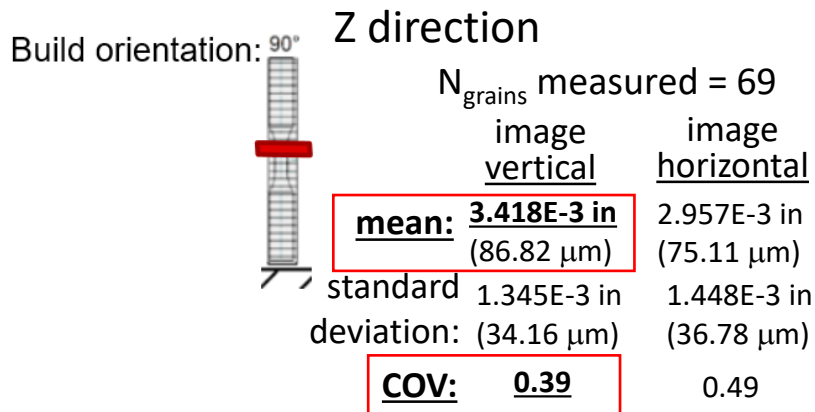
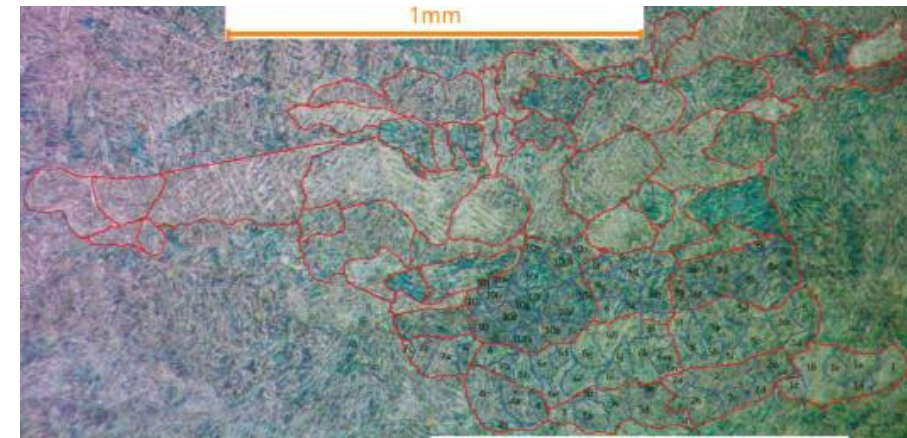
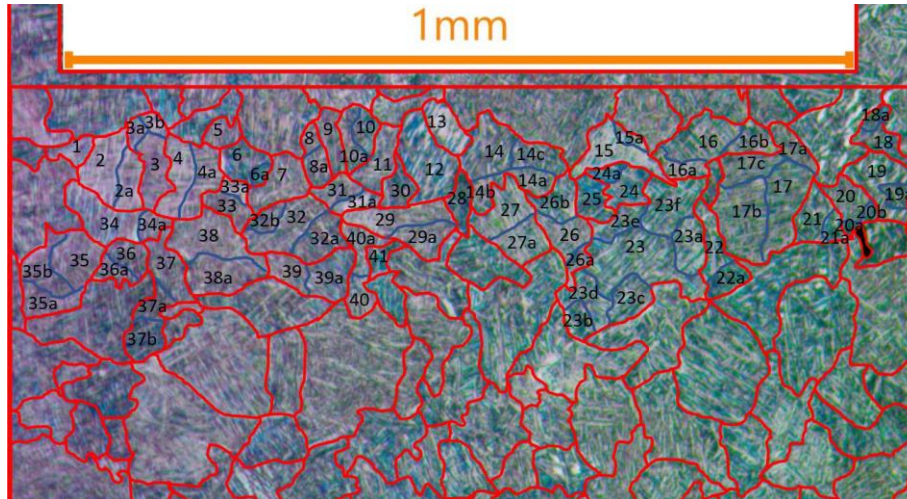
Grain Size and Orientation of PBF AlSi10Mg

- Electron Backscatter Diffraction (EBSD) analysis for microstructural characterization.
- Grain size was determined from the minor axis length of the elliptical fit to grains.

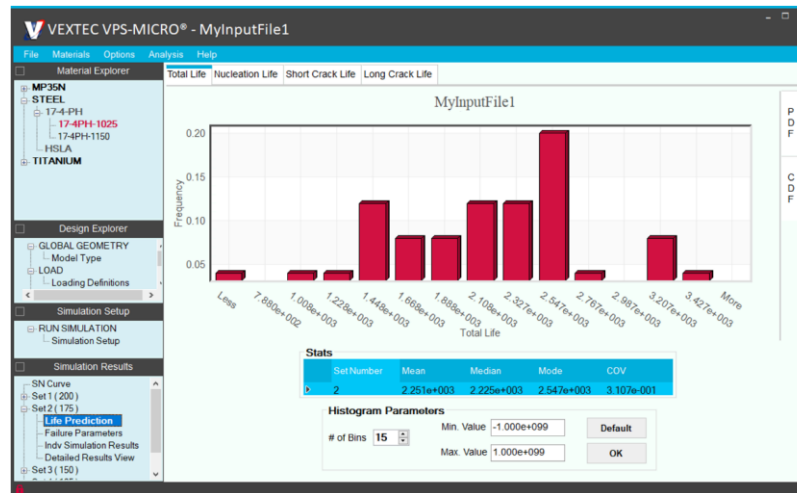


Grain Size Distribution of PBF Ti 64 Specimens

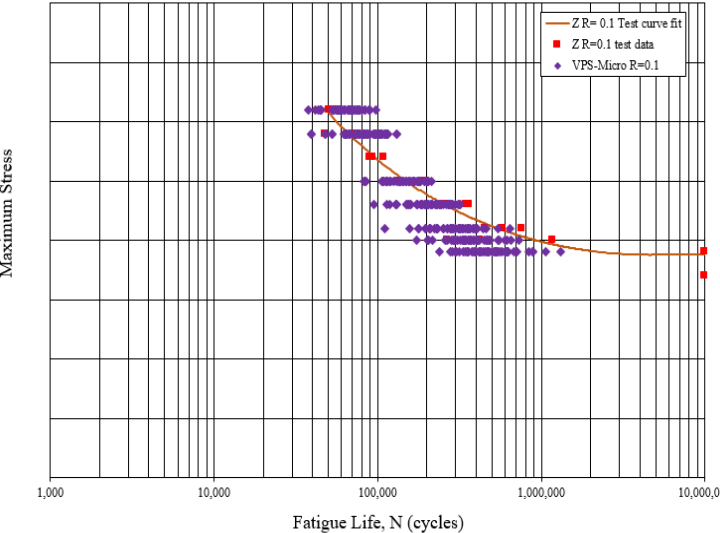
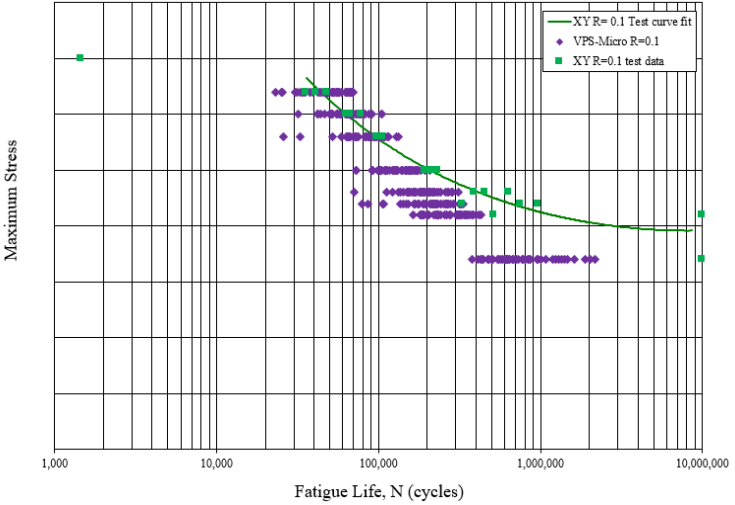
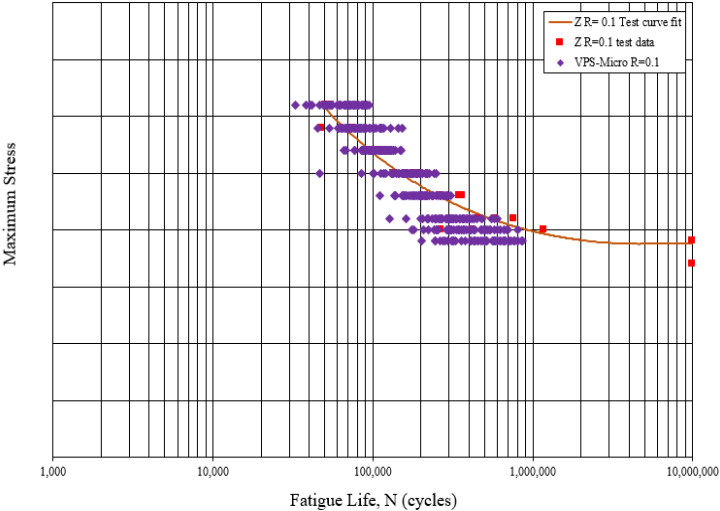
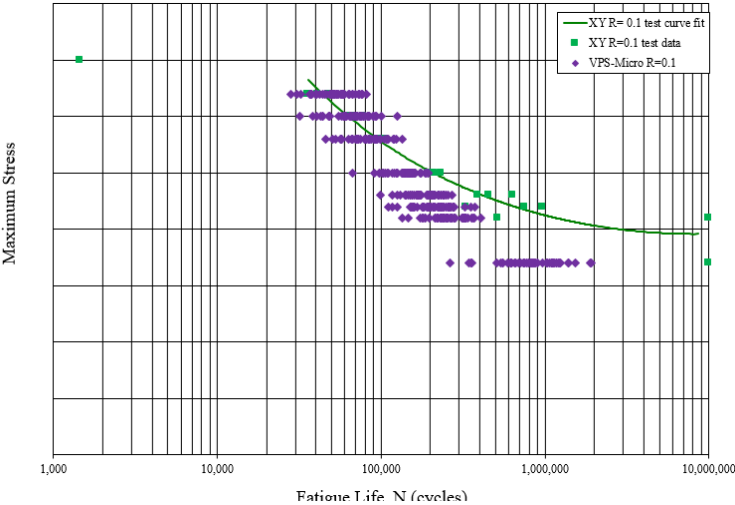
- Grain size is the microstructural feature that determines the length of a slip distance.
- This parameter is probabilistic, and is determined by conventional metallographic techniques



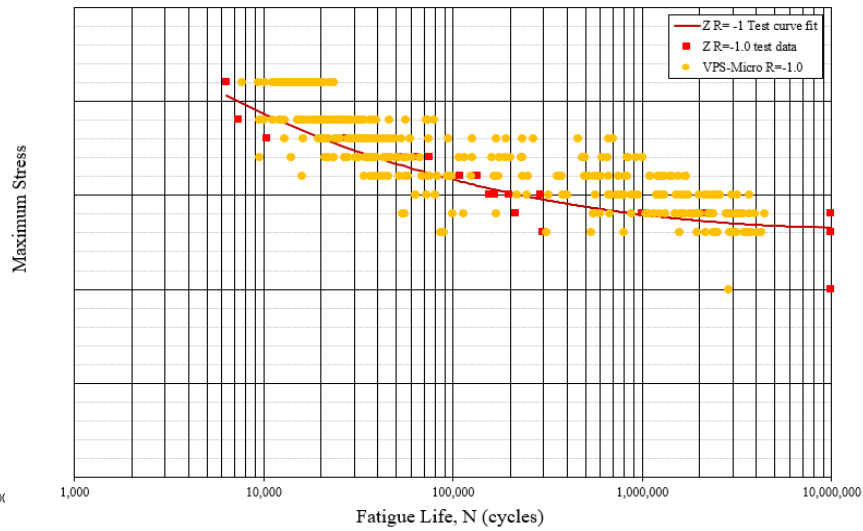
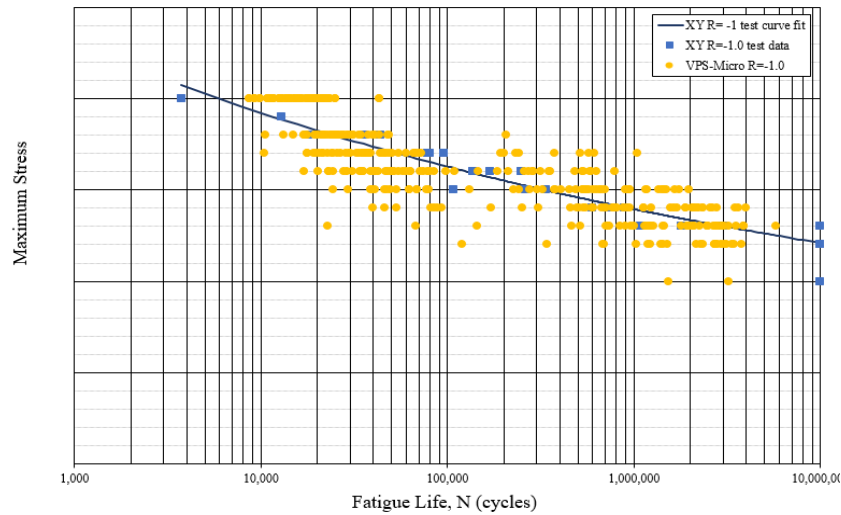
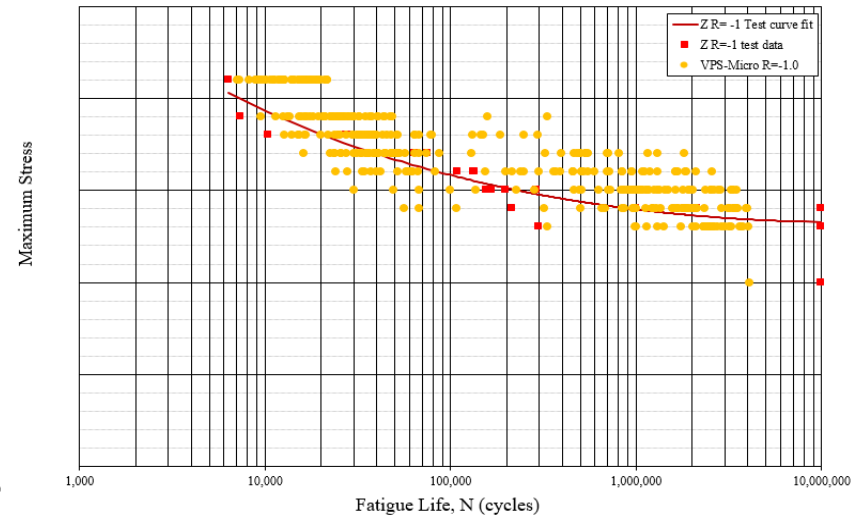
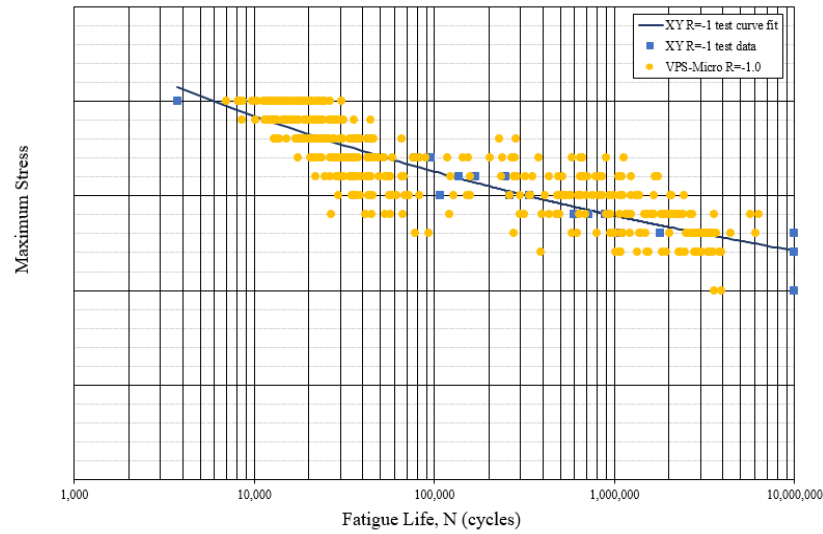
Fatigue Analysis of PBF AlSi10Mg and Ti 6Al-4V



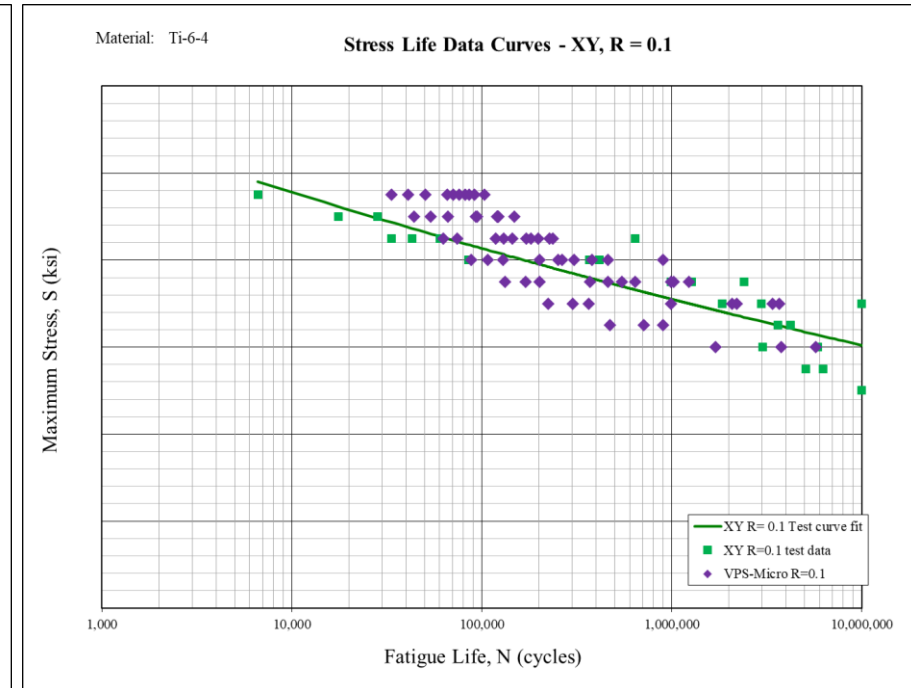
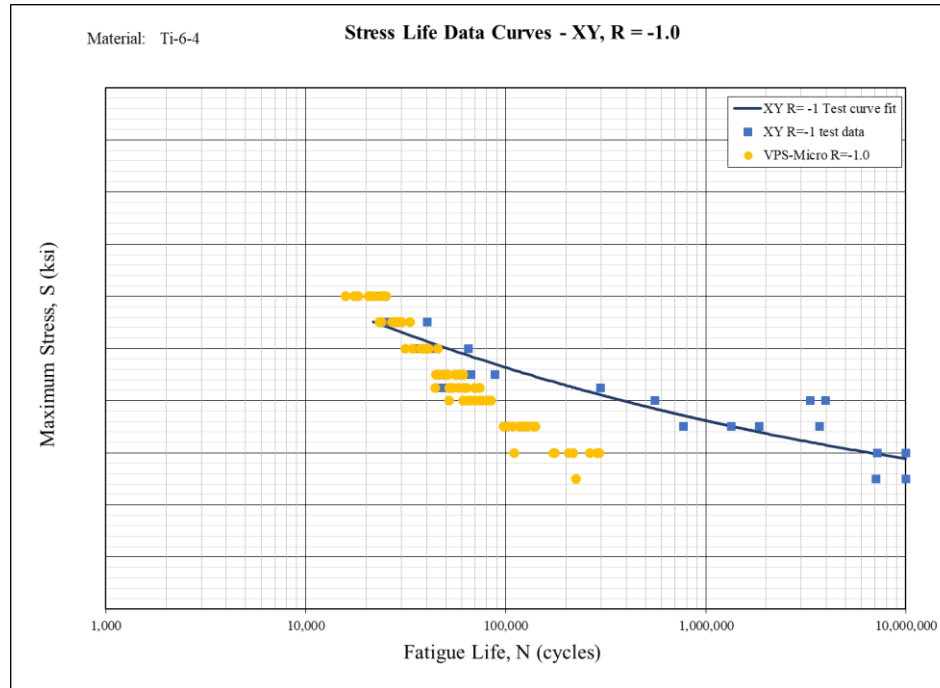
Stress-Life Comparison of AlSi10Mg, R=0.1



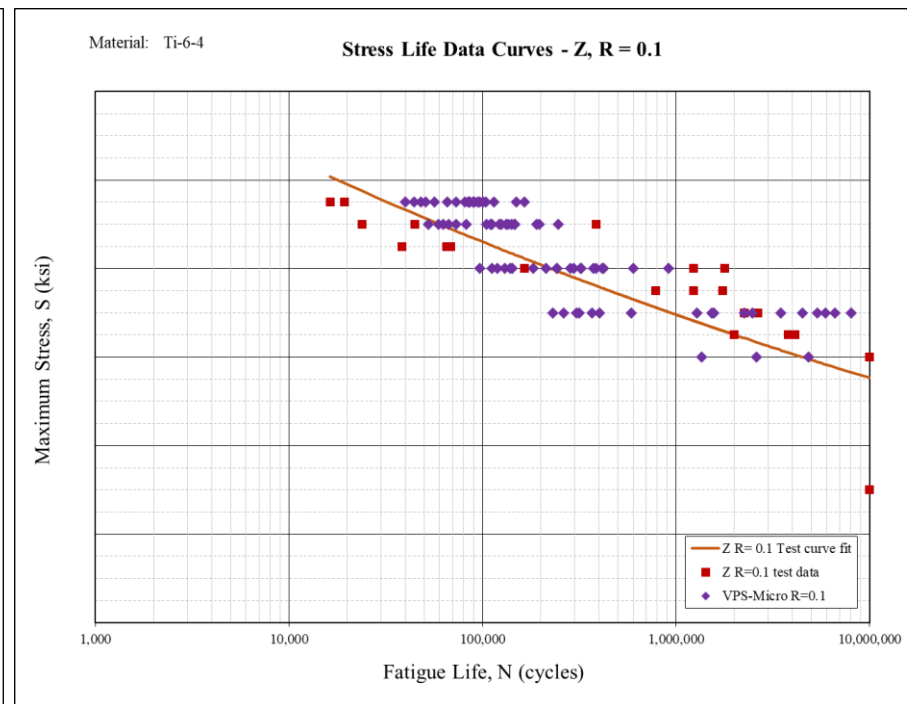
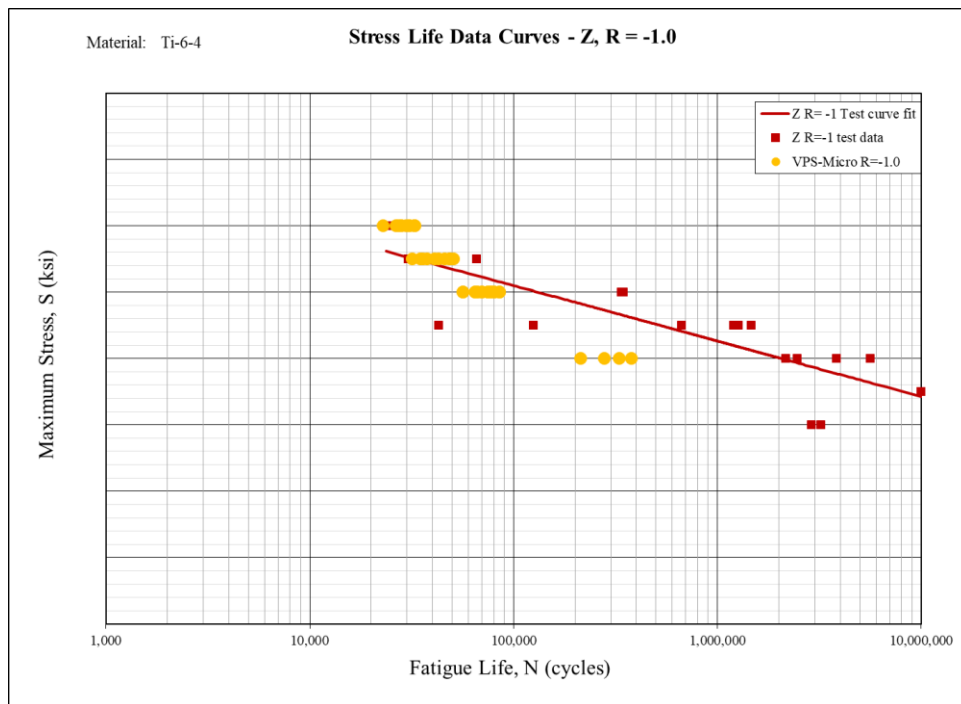
Stress-Life Comparison of AlSi10Mg, R=-1.0



Stress-Life Comparison of Ti 6Al-4V, XY Build Direction



Stress-Life Comparison of Ti 6Al-4V, Z Build Direction



Conclusion and Future Works



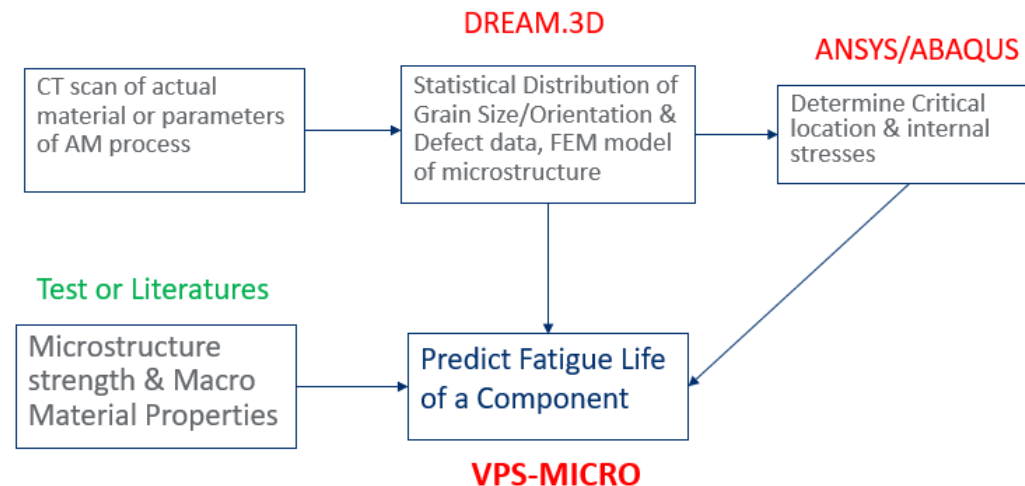
Conclusion

- Fatigue properties of AM materials depend on microstructure such as defects/inclusions and grain size/orientation.
- Microstructure variation is not able to be generalized by deterministic values -> must be represented probabilistically
- VPS-MICRO utilizes the statistics of the microstructure of AM processed materials, AlSi10Mg and Ti 6Al-4V.
 - Statistical distributions of microstructure are obtained and added to VPS-MICRO.
 - Monte Carlo simulation generated microstructural variability
- The comparison of HCF test data and VPS-MICRO indicates the fatigue life predictions are generally in good agreement except xy build direction at R=-1.0 for Ti 6Al-4V.
- Note that full material property development is required for more accurate fatigue life prediction.



Future Works

- Determine Probability of Detection (PoD) of AM parts.
- Establish NDI processes
- Determine IFS for durability and damage tolerance analyses
- Set up the procedure for risk analysis
- Material property determination
 - Generate synthetic structures from experimental statistics. Generate equivalent microstructures/models and represent the statistical nature of materials process and properties
 - Predict microstructure using in-situ data (laser intensity) or thermal history with DREAM.3D



Any Questions?

